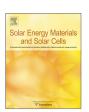
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A recombination analysis of Cu(In,Ga)Se₂ solar cells with low and high Ga compositions



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ABSTRACT

Separation and quantification of recombination losses in thin-film $\text{Cu}(\text{In}_{1-x}\text{Ga}_x)\text{Se}_2$ solar cells is paramount to understanding the current state-of-the-art and future improvements, but an effective characterization technique has been lacking. We use the recently developed temperature–illumination-dependent open-circuit voltage method to extract individual recombination rates at the buffer/absorber interface, in the space-charge region, and in the quasi-neutral region, as well as the carrier lifetime and surface recombination velocity for devices with low (x=30%) and high (x=84%) Ga absorbers. In the low-Ga absorber, recombination in the quasi-neutral region dominates. In the high-Ga absorber, interface recombination dominates. The open-circuit voltage deficit of the high-Ga device originates from an inadequacy of band bending in the absorber and a lack of strong inversion at the buffer/absorber interface. As two promising mitigating strategies for the open-circuit voltage deficit problem at high-Ga levels, we highlight a homojunction in the absorber or alternative transparent conducting oxides with low work function.

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1. Introduction

Cu(In_{1-x}Ga_x)Se₂ (CIGS) thin-film solar cells have achieved impressive power conversion efficiency and are promising for large-scale commercial deployment [1–3]. Further improvement of CIGS conversion technology critically depends on reducing the voltage deficit (i.e., the difference between the open-circuit voltage V_{OC} and bandgap energy of the absorber [4,6,7]) caused by recombination losses distributed across the device. The need to reduce recombination calls for a variety of tactics in material and device engineering, e.g., reducing defects in the absorber to improve minority-carrier lifetime [8], optimizing the buffer/absorber band offset to reduce surface recombination velocity at the interface [9,10], and engineering the heterojunction to maximize the built-in potential [9,10]. To assess the current CIGS state of the art and select appropriate engineering tactics, each recombination loss needs to be separated and quantified-an obvious goal that thus far has remained elusive.

The main tool for recombination analysis in the photovoltaic devices is the temperature-dependent open-circuit voltage $V_{OC}(T)$ technique [11,12], which identifies the dominant recombination mechanism by the activation energy of the recombination extracted

from the intercept of $V_{OC}(T)$ at $T\!=\!0$ K. The technique has been used to qualitatively attribute the voltage deficit in high-bandgap CIGS devices to interface recombination [4,13–15]. However, no quantitative assessment of the recombination rates is possible because the existing technique uses only the 1-dimentional temperature dependence of V_{OC} at a fixed light intensity. We expanded the methodology [16] into an additional dimension by including the light-intensity (i. e., generation G) dependence of V_{OC} . From the 2-dimensional dependence of $V_{OC}(T, G)$, the new method is capable of separating and quantifying recombination rates at the buffer/absorber interface, in the space-charge region (SCR), and in the quasi-neutral region (QNR), all at the V_{OC} point. Furthermore, it is possible to extract intrinsic material properties such as the minority-carrier lifetime in the absorber and surface recombination velocity at the interface.

We use the new method to study the recombination pathways in CIGS devices with low-Ga (x=30%) and high-Ga (x=84%) absorbers. New insights not previously available are provided by quantitative extractions of individual recombination rates at the buffer/absorber interface, in the SCR, and in the QNR, as well as the bulk minority-carrier lifetime and surface recombination velocity at the interface. In the high-bandgap absorbers, we discuss why interface recombination dominates the V_{OC} deficit. We find that inadequate band-bending and interface inversion are the main culprits for high interface recombination and discuss the relative effectiveness of mitigation strategies in the absorber, buffer, buffer/absorber interface, and transparent conducting oxide (TCO).

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2. Experiment

The CIGS/buffer thin-film solar cells used in this study have the same structure as those described in Ref. [4]. Starting from the soda-lime glass substrate, a typical device consists of a 1-μm Mo bilayer deposited by sputtering, 2-µm CIGS absorber deposited by three-stage co-evaporation, 50-nm CdS buffer layer deposited by chemical-bath deposition, bilayer transparent conducting oxide of intrinsic (90 nm) and Al-doped (120 nm) ZnO deposited by sputtering, and a Ni/Al metal-grid front-contact. The devices studied in this work consist of CIGS absorbers with 30% and 84% Ga compositions, corresponding to bandgaps of 1.18 and 1.5 eV. respectively [5]. The 30% Ga composition was chosen because the highest-efficiency CIGS cell is of this composition. The 84% Ga composition was chosen because the voltage deficit is known to be very severe at this Ga composition. High-performance samples are used in this study to represent the current state of the art in the respective ranges of Ga composition [4].

The performance of the devices was measured under a standard AM1.5 condition. We used an Agilent B2912A source-measurement unit for the current-voltage measurement with varying temperature (70–310 K) and light intensity (1×10^{-6} to 1 sun), the latter controlled by a set of neutral-density filters with a Newport 96000 solar simulator. We used an Agilent 4294 A impedance analyzer to conduct the capacitance-voltage (10 kHz, bias from -1.0 to +0.5 V) measurements. Time-resolved photoluminescence (TRPL) [17] was used to measure the minority-carrier lifetime. This measurement was performed on the absorber films, rather than completed devices, to avoid complication due to carrier extraction at the junction. Excitation wavelength was 780 nm, laser repetition rate was 1 MHz, and excitation spot size was 0.25 mm. Photoluminescence signals were measured with an appropriate long-pass filter.

3. Method

The formulation of V_{OC} dependence on generation G, temperature T, and recombination rate is detailed elsewhere [16]; below is a brief summary. Let R^i , R^d , and R^b be the Shockley–Read–Hall [11,18] recombination rates, respectively, at the interface, in the SCR, and in the QNR under a bias V. In this work, the bias can be applied either by an electrical voltage or light at open circuit. Fig. 1 shows the relevant parameters in a band diagram. We express each recombination rate as the product of a V-independent recombination coefficient and an exponential function of V

$$\begin{cases} R^{i} = R_{0}^{i} e^{qV/kT} \\ R^{d} = R_{0}^{d} e^{qV/2kT} \\ R^{b} = R_{0}^{b} e^{qV/kT} \end{cases}$$
 (1)

k is the Boltzmann constant. R_0^i , R_0^b , and R_0^d are the V-independent recombination coefficients at the interface, in the SCR, and in the QNR, in that order. They are essentially the recombination rates at V=0 V and account for the intrinsic material or device properties determining the effectiveness of the respective recombination pathways. The exponential functions of V account for the densities of the carriers limiting the respective recombination rates. Eq. (1) indicates that the ideality factor associated with R^i is 1, which is true when the Fermi energy is pinned and band bending is negligible in the buffer and TCO. Eq. (1) also indicates that the ideality factor associated with R^d is 2. This is true for recombination centers near midgap but may not be true if they are close to the bands [11,19], especially if tunneling is present [11], which can be the case for high-Ga compositions. In the latter case, the same approach described in this work is applicable, but the algebra

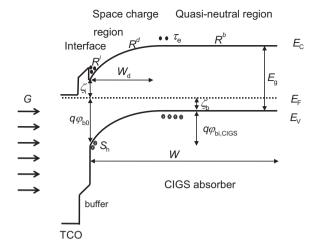


Fig. 1. Band diagram of a CIGS absorber at 0 V bias showing recombination rates in various locations and relevant parameters. G is the optical generation. R^i , R^d , and R^b are the Shockley–Read–Hall recombination rates, respectively, at the interface, in the SCR, and in the QNR. ζ_I is the separation of Fermi energy E_F from the conduction band E_C at the buffer/absorber interface. ζ_b the separation of Fermi energy E_F from the valence band E_V in the QNR of the absorber. φ_{bLCIGS} is the built-in voltage in the absorber. φ_{b0} is the hole potential barrier at the buffer/absorber interface at zero bias. Note $\varphi_{b0} = \zeta_b + \varphi_{bLCIGS}$. S_h is the surface recombination velocity for holes at the buffer/absorber interface. W_d is the depletion width in the absorber. τ_e is the electron lifetime in the absorber.

needs to be modified. Eq. (1) and all derivations in Ref. [16] are valid even if the quasi-Fermi level separation is not constantly V in the entire QNR, as long as the total integrated recombination rate in the QNR R^b is proportional to $e^{qV/kT}$. For a thin absorber (i.e., minority-carrier diffusion length L*absorber thickness W) with negligible surface recombination at the back contact, the quasi-Fermi level separation is constantly V in the entire QNR. Therefore, the recombination coefficients can be expressed as

$$\begin{cases} R_0^{l} = S_h N_V \exp(\frac{-q \omega_{h0}}{kT}) \\ R_0^{d} = \frac{W_d}{\tau_e + \tau_h} n_i \\ R_0^{d} = \frac{W}{\tau_e} \frac{n_i^2}{N_A} \end{cases}$$
 (2)

In Eq. (2), S_h is the surface recombination velocity for holes at the buffer/absorber interface, N_V is the effective density of state in the valence band of the absorber, φ_{b0} is the hole potential barrier at the buffer/absorber interface at zero bias, W_d is the depletion width in the absorber, τ_e is the electron lifetime in the absorber, τ_h is the hole lifetime in the absorber, n_i is the intrinsic carrier density of the absorber, W is the absorber thickness, and N_A is the majority carrier (hole) density. For a thick absorber (i.e., L«W), the minoritycarrier distribution decays exponentially (the decay length being L) away from the SCR, and the spatial integration of R^b leads to replacement of W by L in the expression of R_0^b in Eq. (2). Eqs. (1) and (2) describe factors governing recombination rates in each region. At the interface, R^i is proportional to the surface recombination velocity and density of holes (majority carriers) there. In the SCR, R^d is proportional to the space-charge width, the inverse sum of lifetimes of both carriers, and the density of either carrier where they equal each other. In the QNR, R^b is proportional to a length characterizing the effective recombination volume (e.g., W for a thin absorber and L for a thick absorber as described above), inverse lifetime of electrons, and density of electrons (minority carriers).

By equating the total recombination to generation at $V=V_{OC}$, i.e., $GW=R^i+R^d+R^b$, one uses Eq. (1) to solve the quadratic

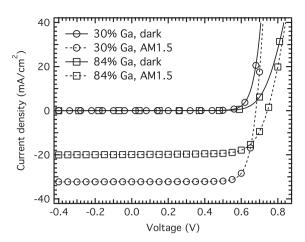


Fig. 2. Light (solid line) and dark (dashed line) current–voltage characteristics measured from the 30% (circles) and 84% (squares) Ga devices. The power conversion efficiency and V_{OC} are 17.4% and 682 mV for the 30% Ga device and 10.8% and 743 mV for the 84% Ga device, respectively.

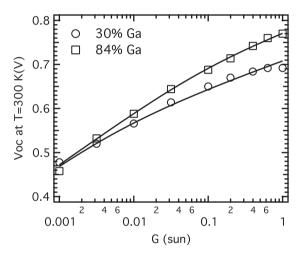


Fig. 3. The dependence of V_{OC} on light-intensity G for both the 30% and 84% Ga devices at 300 K. The experimental data taken from the CIGS device with 30% Ga (circles) are fitted (line) to Eq. (3) for extraction of $R_0^i + R_0^d = 3.4 \times 10^5$ and $R_0^d = 3.3 \times 10^{10}$ cm $^{-2}$ s $^{-1}$. The experimental data taken from the CIGS device with 84% Ga (squares) are fitted (solid line) to Eq. (3) for extraction of $R_0^i + R_0^d = 2.2 \times 10^4$ and $R_0^d = 3.3 \times 10^{10}$ cm $^{-2}$ s $^{-1}$.

equation for $e^{qV/2kT}$ and then for V_{OC}

$$V_{OC} = \frac{2kT}{q} \ln \left[\frac{1}{2} \frac{R_0^d}{R_0^i + R_0^b} \left(\sqrt{4GW \frac{R_0^i + R_0^b}{(R_0^d)^2} + 1} - 1 \right) \right]. \tag{3}$$

 V_{OC} is uniquely determined by recombination coefficients, generation, and temperature, the latter two being experimentally controllable. It can be seen from Eq. (2) that the recombination coefficients depend sensitively on T, but not on G. Therefore, one can extract $R_0^i + R_0^b$ and R_0^d by fitting Eq. (3) to experimental $V_{OC}(G)$ data (e.g., Figs. 2 and 3) taken at a fixed temperature, usually 300 K. In the limit of $4GW(R_0^i + R_0^b)(R_0^d)^{-2}$ »1, the activation energy of recombination E_a (i.e., the intercept of $V_{OC}(T)$ at T=0 K; see Fig. 4 for example) is the mean of absorber bandgap E_g and hole potential barrier $q\varphi_{b0}$ at the interface at zero bias (Fig. 1) weighted by R_0^i and R_0^b .

$$E_a = \frac{R_0^i q \varphi_{b0} + R_0^b E_g}{R_0^i + R_0^b} \tag{4}$$

With knowledge of E_g and φ_{b0} (extracted from capacitance–voltage measurement, see Figs. 1 and 5), the ratio R_0^i/R_0^b is calculated from

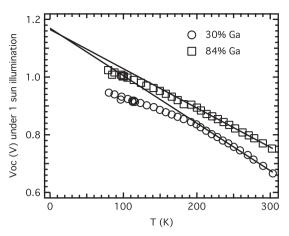


Fig. 4. The dependence of V_{OC} on temperature T under 1-sun illumination. The experimental data taken from the CIGS device with 30% Ga (circles) are fitted to a line for extraction of E_a =1.17 eV, which yields R_0^i/R_0^d =0.1 from Eq. (4). The experimental data taken from the CIGS device with 84% Ga (squares) are fitted to a line for extraction of E_a =1.16 eV, which yields R_0^i/R_0^d =10 from Eq. (4).

 E_a . Knowing both $R_0^i + R_0^b$ and R_0^i / R_0^b allows one to solve the recombination coefficients at the interface R_0^i and in the QNR R_0^b . We then calculate the actual recombination rates in each region R^i , R^b , and R^d at $V = V_{OC}$ from Eq. (1). Finally, Eq. (2) enables the extraction of material and device properties such as electron lifetime τ_e , surface recombination of holes S_h , hole lifetime τ_h , and depletion width W_d . Note that all recombination rates and associated parameters should be regarded as "effective" values averaged out in the respective region. Only the lowest point of the bandgap is used because our devices contain intentional bandgap-grading.

4. Results

The performance of the devices is shown by the dark and light current-voltage characteristics in Fig. 2. The power conversion efficiency η of the 30% Ga device is 17.4% with a V_{OC} of 0.682 V, a short-circuit current density of 32.3 mA/cm², and a fill factor of 79.2%. The power conversion efficiency η of the 84% Ga device is 10.8% with a V_{OC} of 0.743 V, a short-circuit current density of 19.8 mA/cm², and a fill factor of 72.9%. The best cell efficiencies for these two samples are 17.9% and 11.5%, respectively, representing the current state of the art in the respective ranges of Ga composition.

We plot the light-intensity-dependent $V_{OC}(G)$ data measured at 300 K in Fig. 3 and the temperature-dependent $V_{OC}(T)$ data measured under 1-sun illumination in Fig. 4. Note that the shunt resistance may suppress V_{OC} if G is too low. For both devices, this effect occurs below 0.001 sun. For the sample with 30% Ga CIGS absorber, we fit the experimental $V_{OC}(G)$ data (circles in Fig. 3) to Eq. (3) to extract $R_0^i + R_0^b = 3.4 \times 10^5 \text{ cm}^{-2} \text{ s}^{-1}$ and $R_0^d = 3.3 \times 10^{10} \text{ cm}^{-2} \text{ s}^{-1}$. At this point, we verify that 4GW $(R_0^i + R_0^b)(R_0^d)^{-2} = 400$ »1. This inequality allows us to use Eq. (4) to obtain $R_0^i/R_0^d=0.1$ from $E_a=1.17$ eV (extracted from $V_{OC}(T)$ data in Fig. 4), E_g = 1.18 eV, and φ_{b0} = 1.00 V. We extracted φ_{b0} by summing the built-in voltage in the CIGS absorber; $\varphi_{bi,CIGS}$ =0.78 V, extracted by the Mott–Schottky method in Fig. 5(a); and $\zeta_b/q = 0.22 \text{ V}$, where ζ_b is the bulk Fermi level in CIGS calculated from $N_V = 1.8 \times 10^{19} \text{ cm}^{-3}$ taken from Ref. [20] and $N_A = 0.5 \times 10^{16}$ cm⁻³ measured by the capacitance-voltage method in Fig. 5(b). Combining $R_0^i + R_0^d$ and R_0^i / R_0^d yields $R_0^i = 3.1 \times 10^4 \text{ cm}^{-2} \text{ s}^{-1}$ and $R_0^b = 3.1 \times 10^5 \text{ cm}^{-2} \text{ s}^{-1}$. Then we use Eq. (1) to calculate individual recombination rates at the V_{OC} point

 R^i = 1.4 × 10¹⁶ cm⁻² s⁻¹, R^d = 2.2 × 10¹⁶ cm⁻² s⁻¹, and R^b = 1.4 × 10¹⁷ cm⁻² s⁻¹. Note that R^b is the largest of all three recombination rates, indicating that QNR recombination dominates V_{OC} for the 30% Ga device. From R^b_0 and R^i_0 , we use Eq. (2) to obtain the bulk minority-carrier lifetime τ_e = 64 ns and surface recombination velocity S_h = 2.6 × 10³ cm/s, respectively.

For the sample with the 84% Ga CIGS absorber, we use the same procedure to extract the recombination coefficients $R_0^i = 2.0 \times 10^4 \text{ cm}^{-2} \text{ s}^{-1}$, $R_0^d = 3.3 \times 10^{10} \text{ cm}^{-2} \text{ s}^{-1}$, and $R_0^b = 2.0 \times 10^3 \text{ cm}^{-2} \text{ s}^{-1}$. We extracted $\varphi_{b0} = 1.12 \text{ V}$ by summing the built-in voltage in the CIGS absorber; $\varphi_{bi,CIGS} = 0.90 \text{ V}$, extracted by the Mott–Schottky method in Fig. 5(a); and $\zeta_b/q = 0.22 \text{ V}$, where ζ_b is the bulk Fermi level in CIGS calculated from $N_V = 1.8 \times 10^{19} \text{ cm}^{-3}$ taken from Ref. [20] and $N_A = 0.5 \times 10^{16} \text{ cm}^{-3}$ measured by the capacitance–voltage method in Fig. 5(b). Note that the same N_V is

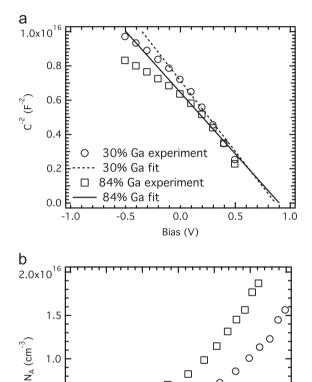


FIG. 5. (a) The Mott–Schottky plots for 30% Ga (circles) and 84% Ga (squares) measured at 10 kHz and 300 K are used to extract the built-in voltage, which is about $\varphi_{bi,CIGS}$ when the band bending in the buffer is neglected. Five data points from 0 to +0.4V bias are used for the linear fitting to yield $\varphi_{bi,CIGS}$ of 0.78 V and 0.90 V for the 30% Ga and 84% Ga devices, respectively. (b) The depth profiles of carrier density calculated from the capacitance–voltage measurement at 10 kHz and 300 K are used to extract majority-carrier density N_A =0.5 × 10¹⁶ cm⁻³ and the bulk Fermi level ζ_b =0.22 eV in CIGS for both devices. N_A is taken from the lowest point of the curve to minimize the effect of deep levels.

0.35

 W_d (μ m)

0.30

30% Ga

84% Ga

0.45

0.50

0

0.40

0.5

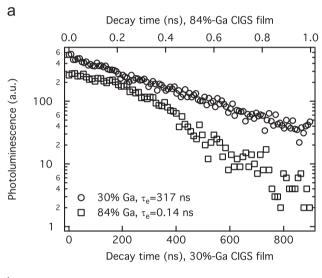
0.0

0.20

0.25

used for both samples because of a lack of available data, but it could change with Ga composition if the effective mass of holes is changed. The recombination rates are $R^i = 9.1 \times 10^{16} \, \mathrm{cm}^{-2} \, \mathrm{s}^{-1}$, $R^d = 7.0 \times 10^{16} \, \mathrm{cm}^{-2} \, \mathrm{s}^{-1}$, and $R^b = 9.1 \times 10^{15} \, \mathrm{cm}^{-2} \, \mathrm{s}^{-1}$. Note that R^i is the largest of all three recombination rates, indicating that interface recombination dominates V_{OC} for the 84% Ga absorber. From R^d_0 and R^i_0 , we obtain $\tau_e = 0.05$ ns and $S_h = 7.9 \times 10^3 \, \mathrm{cm/s}$ in this device. The recombination parameters extracted from both the low-Ga and high-Ga devices are summarized in Table 1.

To verify accuracy of some of the aspects of the $V_{OC}(T)$ analysis described above, we used TRPL measurement to independently measure minority-carrier lifetime. TRPL measurements were carried out on CIGS absorbers immediately after deposition to avoid possible degradation effects [21]. Fig. 6a shows that TRPL decay for CIGS absorber with 30% Ga is single-exponential and has τ_e =317 ns lifetime. In contrast, TRPL decay for CIGS film with 84% Ga has a very short lifetime. Deconvolution of the



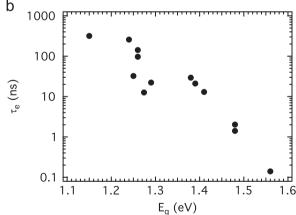


Fig. 6. (a) The semi-logarithmic display of time-resolved photoluminescence (TRPL) decays for CIGS films with 30% Ga (circles) and 84% Ga (squares). Linear fittings yield minority-carrier lifetime of 317 and 0.14 ns, respectively. (b) The TRPL-measured minority-carrier lifetimes are displayed against the bandgap of CIGS films varied due to Ga composition.

 Table 1

 Summary of device performance and extracted recombination parameters.

| Ga (%) | V_{OC} (mV) | η (%) | R^{i} (cm ⁻² s ⁻¹) | $R^d (cm^{-2} s^{-1})$ | $R^b (\text{cm}^{-2} \text{s}^{-1})$ | $R_0^i \text{ (cm}^{-2} \text{ s}^{-1})$ | $R_0^d \text{ (cm}^{-2} \text{ s}^{-1}\text{)}$ | $R_0^b (\mathrm{cm}^{-2} \mathrm{s}^{-1})$ | τ _e (ns) | S_h (cm/s) | E_a (eV) | E_g (eV) |
|--------|---------------|-------|---|------------------------|---------------------------------------|--|---|--|---------------------|--------------|------------|------------|
| 30 | 682 | | 1.4e16 | 2.2e16 | 1.4e17 | 6.4e4 | 3.3e10 | 3.4e5 | 64 | 2.6e3 | 1.17 | 1.18 |
| 84 | 743 | | 9.1e16 | 7.0e16 | 9.1e15 | 2.0e4 | 3.3e10 | 2.0e3 | < 0.05 | 7.9e3 | 1.16 | 1.50 |

instrumental response [22] was used to determine τ_e =0.14 ns. Fig. 6b shows the TRPL lifetime dependence on Ga composition for additional CIGS films. Lifetime decreases by more than three orders of magnitude when the Ga composition increases from 30% to 84%. Within experimental error and material fluctuation, the lifetime values extracted above by $V_{OC}(G,T)$ analysis agree well with TRPL results.

Assuming electron mobility of 100 cm² V⁻¹ s⁻¹, we further estimate the minority-carrier diffusion length L to be 4.5 and 0.1 µm for the 30% and 84% Ga devices, respectively, which is consistent with the quantum efficiency (data not shown) and cross-sectional scanning electron-beam-induced current experiment (Figs. 5 and 8 in Ref. [4] for low- and high-Ga samples. respectively, similar to those used in this study). For the device with 30% Ga, the thin-absorber approximation holds and Eq. (2) is valid for extraction of τ_e . However, for the device with 84% Ga, L«W, which indicates that the thick-absorber approximation should be used. Therefore, W should be replaced with L in the expression of R_0^b in Eq. (2), which leads to τ_e =0.2 ps. However, this value is too close to those of other physical processes such as electron thermalizaton and drift in the pn junction. Some assumptions used in the $V_{OC}(G,T)$ analysis do not accurately reflect the carrier recombination dynamics on such a short time scale. Therefore, we can only use 0.05 ns as the upper limit of electron lifetime for the device with 84% Ga.

5. Discussion

We now inspect more closely the recombination coefficients and rates in the context of varying bandgap energy. To do so, we rearrange Eqs. (1) and (2) to express all the recombination rates in similar forms

$$\begin{cases} R^{i} = R_{0}^{i} e^{qV/kT} = S_{h} N_{V} \exp\left(\frac{\zeta_{i} - E_{g}}{kT}\right) \exp\left(\frac{qV}{kT}\right) \\ R^{d} = R_{0}^{d} e^{qV/2kT} = \frac{W_{d}}{\tau_{e} + \tau_{h}} \sqrt{N_{C} N_{V}} \exp\left(\frac{-E_{g}}{2kT}\right) \exp\left(\frac{qV}{2kT}\right). \end{cases}$$

$$(5)$$

$$R^{b} = R_{0}^{b} e^{qV/kT} = \frac{W}{\tau_{e}} \frac{N_{C} N_{V}}{N_{A}} \exp\left(\frac{-E_{g}}{kT}\right) \exp\left(\frac{qV}{kT}\right).$$

In Eq. (5), N_C is the effective density of states in the conduction band of the absorber, ζ_i is the separation of Fermi energy E_F from the conduction band E_C at the buffer/absorber interface, and ζ_b is the separation of Fermi energy E_F from the valence band E_V in the QNR of the absorber. Each recombination rate is thus the product of four terms. From left to right, these four terms are: (i) a recombination velocity; here, we refer to $W_d/(\tau_e+\tau_h)$ as the SCR recombination velocity and W/τ_e as the QNR recombination velocity; (ii) an intrinsic carrier density, which is a fundamental property of the absorber; (iii) the dependence of the recombination-dominating carrier density on material (bandgap and doping) and junction (band-bending) properties, which will be discussed more extensively in the next sections; and (iv) the exponential bias dependence. Note that although N_A is constant over temperature [11,16] in most cases, it could vary with temperature according to the Boltzmann approximation of $N_V \exp(-\zeta_{\rm b}/kT)$. The former scenario is often true near room temperature and yields $E_a=E_g$. The latter scenario may be true at lower temperatures (or if the dopants levels are relatively deep) and yields $E_a = E_g - \zeta_b$ —i.e., term (ii) changes to $(\zeta_b - E_g)/kT$.

The fourth term in Eq. (5) indicates that the recombination rates increase exponentially with bias, but with different exponents: qV/2kT for R^d as opposed to qV/kT for R^i and R^b . Although the SCR recombination coefficient R^d_0 is much larger (Table 1) than that of either the interface R^i_0 or the QNR R^b_0 , the SCR recombination rate R^d only dominates at low to moderate biases. Because the function $e^{qV/kT}$ is much faster than $e^{qV/2kT}$, the SCR recombination

rate R^d is eventually overtaken by those at the interface R^i and in QNR R^b at high biases. Especially in the state-of-the-art CIGS devices used in this study (Table 1), the recombination rate in the SCR R^d at V_{OC} is less than the sum of those at the interface and QNR $R^i + R^b$. Therefore, V_{OC} of these devices are limited by either interface recombination or QNR recombination.

The third term in Eq. (5) contains an exponential dependence on the bandgap energy: $\exp(-E_g/kT)$. This suggests that, all else being equal, the recombination coefficients as well as rates in all three regions *decrease exponentially* with increasing bandgap energy of the absorber. Considering that the generation rate G due to the sun spectrum only decreases slightly with E_g , V_{OC} increases linearly to the first order with E_g because $V_{OC} = \ln(GW/R_0^{\text{dominant}})nkT/q$, where R_0^{dominant} is the coefficient of the dominant recombination mechanism and n=1 or 2 depending on the dominant recombination mechanism. This is the rationale for pursuing higher-bandgap absorbers. Up to a point, V_{OC} indeed increases linearly with E_g in experiment ([4,13–15]). Beyond that, other factors overrule the benefit of recombination reduction by increasing E_g . We discuss some of these factors below.

Next, we focus on a detailed comparison of the interface and QNR recombination, which also expands the discussion on the third term in Eq. (5). We obtain an expression for the ratio of R^i/R^b from Eq. (5)

$$\frac{R^{i}}{R^{b}} = \frac{N_{A}}{N_{C}} \frac{S_{h}}{W/\tau_{e}} \exp\left(\frac{\zeta_{i}}{kT}\right). \tag{6}$$

The voltage-dependence term in Eq. (5) disappears because it is the same for R^i and R^b . The right-hand side of Eq. (6) consists of three terms. The first term N_A/N_C is intrinsic to the material, and it can be improved through engineering of doping (N_A) or effective mass (N_C) . The second term $S_h/W\tau_e^{-1}$ is the ratio between the recombination velocity at the interface and that in the QNR (i.e., $W\tau_e^{-1}$). This term evaluates the material quality of the interface relative to that of the QNR in terms of its recombination effectiveness. For a specific absorber with minority-carrier lifetime τ_e , it is desirable to have $S_h < W\tau_e^{-1}$ in order for the interface recombination quality to surpass that of the QNR. Obviously, a large W helps. Alternatively, S_h needs to be sufficiently small. An example is for τ_e =100 ns and W=2 μ m, where S_h needs to be <2 \times 10 3 cm/s for the interface material quality to be superior to that of the QNR.

Unlike the first two terms, the third term $\exp(\zeta_i/kT)$ in Eq. (6) is intrinsic not to material, but rather, to device architecture because it is an assessment of the inversion strength (ζ_i) at the interface. The stronger the inversion, the smaller is the value of ζ_i , and hence, the less significant is interface recombination compared to bulk recombination. Therefore, a strong inversion helps to tolerate an interface with poor recombination quality characterized by large S_h . This is the rationale behind the pursuit of alternative buffers with proper band offset. A "spike" type offset between the conduction bands of the absorber and the buffer (as shown in Fig. 1) provides the necessary potential confinement to minority carriers, thus favoring inversion. This is an especially important subject for devices of higher-bandgap absorbers due to shifts of the conduction and valence bands.

Compared to the low-Ga sample, it is surprising that R^i/R^b is \sim 100 times higher in the high-Ga sample considering τ_e is at least \sim 1000 times *worse*. One obvious factor is R_b^0 , which is proportional to W (2 μ m) for the low-Ga sample but to L (10 nm) for the high-Ga sample according to Eq. (2). A more important key lies in ζ_i , which is 0.1 and 0.38 eV in the low-Ga and high-Ga samples, respectively. Since ζ_b is \sim 0.22 eV for both samples, a strong inversion is achieved in the low-Ga sample but not in the high-Ga sample. According to Eq. (6), R^i/R^b is dominated by $\exp(-\zeta_i/kT)$. For a ζ_i difference of 0.28 eV, $\exp(-0.28 \text{ eV/kT}) = 5.2 \times 10^4$, causing

 R^{i}/R^{b} to be ~ 100 times higher in the high-Ga sample despite lower τ_e . Therefore, the reason for V_{OC} to be limited by interface recombination in the high-bandgap devices is essentially a weakness or even absence of inversion due to insufficient band bending in the absorber. Because R^i/R^b increases with decreasing temperature according to Eq. (6), the interface recombination becomes more dominant at lower temperatures for the high-Ga sample (recall that $R^i/R^b = 10$ at room temperature). According to Eq. (4), E_a =1.16 eV is already very close to $q\varphi_{b0}$ =1.12 eV at room temperature. At lower temperatures, E_a becomes even closer to $q\varphi_{b0}$, but the numerical change is small because of the large R^i/R^b value, resulting in a $V_{OC}(T)$ curve with a constant slope over the entire temperature range in Fig. 4. For the low-Ga sample, the smaller E_a below 200 K could indicate either: R^i/R^b growing to > 1 below 200 K, hence, becoming interface recombination dominant; or, majority-carrier density N_A ceasing to be temperature independent below 200 K, hence, E_a changing from E_g to $E_g - \zeta_b$.

How then does one increase inversion at the interface? Fig. 1 shows that $\zeta_i = E_g - q \varphi_{bi,CIGS} - \zeta_b$, where $\varphi_{bi,CIGS}$ is the band bending in the CIGS absorber. Suppressing interface recombination by strong inversion (low ζ_i) is thus inherently more challenging as E_g increases. Increasing ζ_b by reducing doping in CIGS directly reduces R^i/R^b by reducing ζ_i , although this effect may be compromised by an accompanying reduction in $\varphi_{bi,CIGS}$. For the purpose of reducing ζ_i , by far the most rewarding strategy is to pursue higher $\varphi_{bi,CIGS}$ —a figure of merit more effectively engineered via optimization of device architecture than material quality.

Based on the above results and discussion, we compare the high-Ga state-of-the-art absorbers with their low-Ga counterparts to summarize the major mechanisms limiting the present performance and mitigation strategies: (i) A higher E_g reduces recombination rates due to their exponential dependence $\exp(-E_g/kT)$ in Eq. (5). This is the main driver for potential higher performance in high-Ga absorbers and is experimentally observed in the linear increase of V_{OC} with E_g up to a point. (ii) As shown by both the $V_{OC}(T,G)$ analysis and TRPL in Fig. 6(b), the bulk minority-carrier lifetime τ_e is much smaller in high-Ga absorbers, which suggests that these materials are more defective and in need of improvement (e.g., by tuning growth temperature [4]). (iii) The surface recombination velocity S_h being only moderately higher indicates that the recombination quality of the CdS/CIGS interface is not significantly deteriorated by a higher E_g . (Note that the recombination rate depends on two factors: the recombination qualitythat is, effectiveness of recombination characterized by lifetime and surface recombination velocity-and carrier density.) This suggests that a satisfactory passivation effect may be achieved by chemical-bath-deposited CdS on high-Ga CIGS absorbers. (iv) Because the conduction band-edge E_C moves up with Ga composition [23], the buffer/absorber band offset becomes less favorable for inversion [this is the carrier density factor mentioned in (iii)], thus increasing the interface recombination rate R^{i} . This can be mitigated by alternative buffers with lower electron affinity to achieve proper conduction band offset. (v) The hole density N_A is essentially unchanged, which means the same Fermi-level positioning relative to E_V (i.e., ζ_h)—a fortunate situation requiring no further improvement in doping for the moment. (vi) Neither a higher E_g nor a higher E_C in the absorber increases the built-in voltage (i.e., total band-bending in the heterojunction). Because the built-in voltage is determine by the difference of E_F in the bulk of the TCO and CIGS absorber (see Fig. 1), nothing short of raising E_F on the n-type side (TCO most likely dominates the buffer) or lowering E_F on the p-type side can be effective at increasing it directly. Since both ζ_b and E_V on the p-type side is relatively unchanged by Ga composition (although alloying with sulfur may be more effective in lowering E_V and E_F while achieving higher E_g), an alternative TCO with low work function is more promising for

raising E_F on the n-side and directly enhancing the total bandbending of the heterojunction. This, in turn, increases $\varphi_{bi,CIGS}$, which decreases the interface-vs-bulk recombination ratio in Eq. (6). (vii) Unlike the case of the low-Ga absorber [24], it is unclear whether a homojunction can be formed entirely in the high-Ga CIGS absorber. In optimized n-type CIGS, E_F is close to E_C and will move up with E_C as Ga composition increases. Therefore, a homojunction in the high-Ga CIGS may enable higher $\varphi_{bi,CIGS}$ than the buffer/CIGS heterojunction, where $\varphi_{bi,CIGS}$ is limited by the relative immovability of E_F on the n-side with increasing Ga composition. In high-Ga absorbers, a CIGS homojunction is thus superior to a heterojunction architecture for achieving higher $\varphi_{bi,CIGS}$, lower interface recombination, and higher V_{OC} .

6. Conclusions

We demonstrate that the recently developed formulation of $V_{OC}(T,G)$ is effective in separating and quantifying individual recombination rates at the buffer/absorber interface, in the SCR, and in the QNR, as well as the bulk minority-carrier lifetime and surface recombination velocity at the buffer/absorber interface of thin-film CIGS solar cells. In the low-bandgap absorbers, recombination in the quasi-neutral region dominates. In the high-bandgap absorbers, interface recombination dominates because of a lack of strong inversion at the interface caused by insufficient band bending in the absorber. The V_{OC} deficit in high-bandgap devices originates from an inadequacy of band bending in the absorber and a weakness or absence of inversion at the buffer/absorber interface. Reducing interface recombination is inherently more challenging in high-bandgap devices and should take priority. In particular, it is imperative to engineer the absorber/buffer/TCO junction to achieve higher band-bending in the absorber and stronger inversion at the interface. The CIGS homojunction or alternative n-TCOs with low work function are two promising mitigating strategies for the V_{OC} deficit problem at high-Ga levels.

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